

Pressure Sensor

PS-A (ADP5) series

(Built-in amplification and temperature compensating circuit)

Built-in amplifier and compensating circuit

Feature

- Built-in amplifier and temperature compensation circuit, no need for circuit design and characteristic adjustment.
- High accuracy and reliability: overall accuracy ±1.25% FS (Standard), ±2.5% FS (Low-pressure type)
- Compact size, space-saving : compatible size for PS type (Standard/Economy, S and M packages)
- RoHS compliant

Typical applications

Industrial use : Pressure switches and pneumatic components, compressed air pressure measuring devices

Medical use : Airbeds

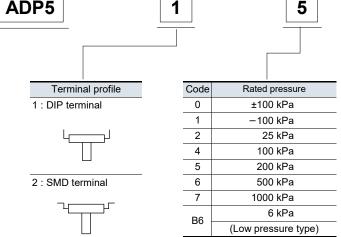
Others : Pressure sensing devices for air pressure mediums

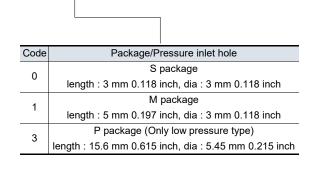
[Low-pressure type]

• Water level detection for domestic appliances : Washing machines and dishwashers

Air pressure control : Cleanrooms and smoking rooms

Ordering information





Note: Some part numbers may not be available depending on the combination.

Please refer to the Table of PRODUCT TYPES on the next page.

Product types

Standard packing: Carton: 100 pcs.; Case: 1,000 pcs.

Dealer			Part No.				
	Package (Pressure inlet hole length)		Standard type		Standard / Economy type		Low pressure type
			S package (3 mm 0.118 inch)		M package (5 mm 0.118 inch)		P package (15.6 mm 0.614 inch)
Pre	essure	Terminal	DIP terminal	SMD terminal	DIP terminal	SMD TErminal	DIP terminal
	Standard type (with glass base)						
	±100 kPa		ADP5100	ADP5200	ADP5101	ADP5201	_
	-100 kPa		ADP5110	ADP5210	ADP5111	ADP5211	_
	25 kPa		ADP5120	_	ADP5121	_	_
	100 kPa		ADP5140	ADP5240	ADP5141	ADP5241	_
	200 kPa		ADP5150	ADP5250	ADP5151	ADP5251	_
	500 kPa		ADP5160	ADP5260	ADP5161	ADP5261	_
	1000 kPa		ADP5170	ADP5270	ADP5171	ADP5271	_
	Low pressure type						
	6 kPa		_	_	_	_	ADP51B63

Rating

Standard type

Item	Standard type (with glass base)					
Type of pressure	Gauge pressure					
Pressure medium	Air ^{*1}					
Rated pressure (kPa)	±100 -100 25 100 200 500			1000		
Max. applied pressure	Twice of the rated pressure			1.5 times the rated pressure		
Ambient temperature	-10 °C to +60 °C 14 °F to +140 °F (no freezing or condensation)					
Storage temperature	-20 °C to +85 °C -4 °F to +185 °F (no freezing or condensat		ndensation)			
Drive voltage	5±0.25 V					
Temperature compensation range	0 ℃ to 50 ℃ 32 ℉ to 122 ℉					
Offset voltage*2,3,5	2.5±0.05 V 0.5±0.05 V					
Rated output voltage ^{*2,3,5}	4.5±0.05 (+when +100kPa) 4.5±0.05 V					
Overall accuracy	±1.25 %FS* ^{3,4,5}					
Current consumption	Max. 10 mA*2,3					

^{*1:} Please consult us for pressure media other than dry air, nitrogen, oxygen, carbon dioxide.

Low pressure type

Item	Economy type (without glass base)
Type of pressure	Gauge pressure
Pressure medium	Air ^{*1}
Rated pressure (kPa)	6
Max. applied pressure	Twice of the rated pressure
Ambient temperature	0 °C to +70 °C 32 °F to +158 °F (no freezing or condensation)
Storage temperature	-30~% to +100 $%$ $-22~%$ to +212 $%$ (no freezing or condensation)
Drive voltage	5±0.25 V
Temperature compensation range	0 ℃ to 70 ℃ 32 ℉ to 158 ℉
Offset voltage	0.5 V (Typical) ^{*2}
Span voltage	4.0 V (Typical)*2
Overall accuracy	±2.5 %FS ^{*2,3,4}
Current consumption	Max. 10 mA

^{*1:} Please consult us for pressure media other than dry air, nitrogen, oxygen, carbon dioxide.

^{*3:} Indicates output when drive voltage is 5 V. Although output fluctuates due to fluctuations in the drive voltage, this is not included.

^{*4:} Overall accuracy indicates the accuracy of the offset voltage and rated output voltage at a temperature compensation range of 0 to 50 ℃ 32 to 122 ℉.

^{*5:} Accuracy is the value at the time of our shipping. Please set Zero-point calibration function on your products in order to safely use if the offset voltage is shifted.

^{*2:} Indicates output when drive voltage is 5 V. Although output fluctuates due to fluctuations in the drive voltage, this is not included.

^{*3:} Overall accuracy indicates the accuracy of the offset voltage and span voltage at temperatures between 0 to 70 °C 32 to 158 °F (FS=4V)

^{*4:} The initial offset voltage error is not included in the overall accuracy.

Reference data

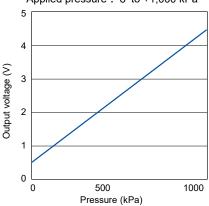
[Standard type]

1. −① Output voltage

(Representative example : ADP5170)

Drive voltage: 5 V Temperature: 25 ℃ 77 °F

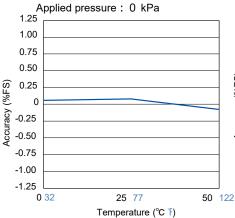
Applied pressure: 0 to +1,000 kPa



 1. −② Overall accuracy (Offset voltage)

(Representative example : ADP5170)

Drive voltage: 5 V

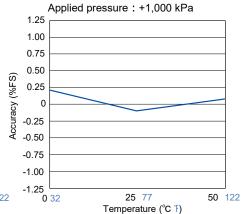


 1. −③ Overall accuracy (Rated output voltage)

(Representative example : ADP5170)

Drive voltage: 5 V

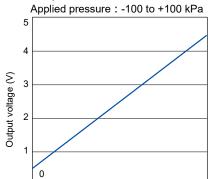
Temperature. : 0 to 50 ℃ 32 to 122 ℉



2. - 1 Output voltage

(Representative example: ADP5100)

Drive voltage : 5 V Temperature : 25 ℃ 77 ℉



0

Pressure (kPa)

100

0

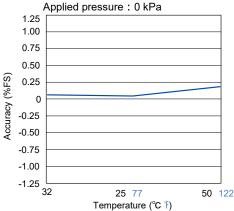
-100

2. -② Overall accuracy (Offset voltage)

(Representative example: ADP5100)

Drive voltage: 5 V

Temperature : 0 to 50 ℃ 32 to 122 ℉



 -3 Overall accuracy (Rated output voltage)

(Representative example : ADP5100)

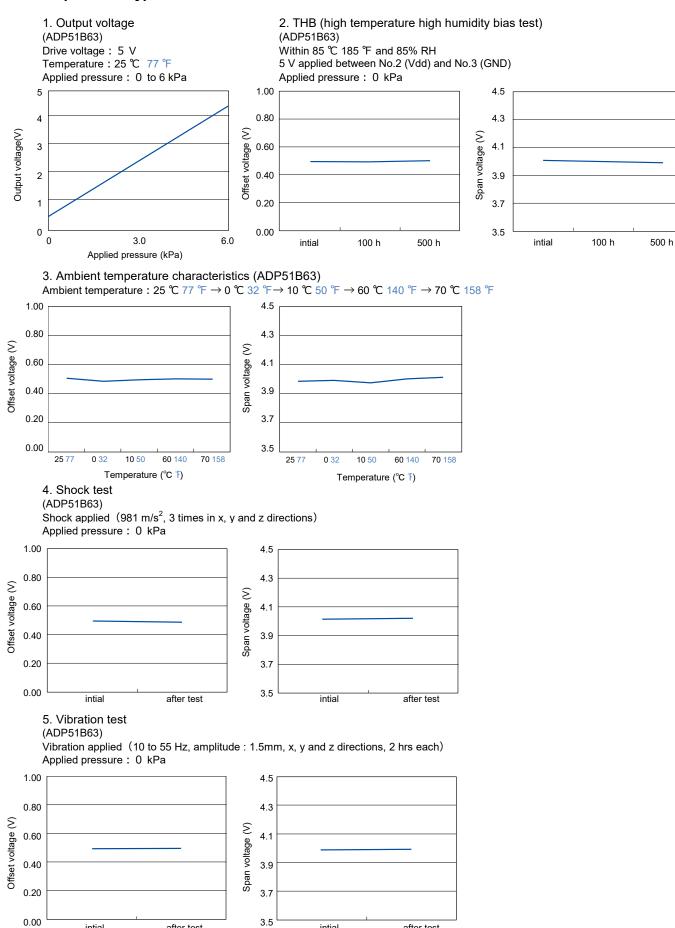
Drive voltage: 5 V

Temperature: 0 to 50 ℃ 32 to 122 ℉

Applied pressure: +100 kPa 1.25 1.00 0.75 0.50 0.25 Accuracy (%FS) -0.25 -0.50 -0.75 -1.00 -1.25 32 25 77 50 122 Temperature (°C T)

Reference data

[Low pressure type]



intial

after test

intial

after test

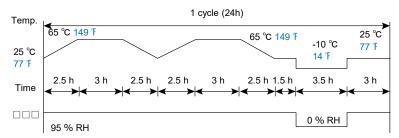
Reference data

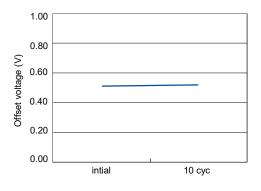
6. Temperature/humidity cycle test

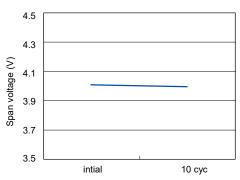
(ADP51B63)

Exposed to 10 cycles in the temperature and humidity conditions given below.

Applied pressure: 0 kPa







		44
131/61	luation	TACET

Classifi cation	Tested item	Tested condition		Result	
	Storage at high	Temperature	: Left in a 85 $^{\circ}$ C 185 $^{\circ}$ F constant temperature bath	Passed	
	temperature	Time	: 100 hrs	i asseu	
	Storage at low	Temperature	: Left in a –20 ℃ –4 ℉ constant temperature bath	Passed	
Environmental	temperature	Time	: 100 hrs		
characteristics	Humidity	Temperature/humidity	: Left at 40 ℃ 104 ℉, 90 % RH	Passed	
Grandotoriotico	riumuity	Time	: 100 時間	rasseu	
		Temperature	: –20 ℃ to 85 ℃ –4 ℉ to 185 ℉		
	Temperature cycle	1 cycle	: 30 min	Passed	
		Times of cycle	: 100 cycle		
Endurance	High temperature/	Temperature/humidity	: 40 ℃ 104 ℉, 90% RH	Passed	
characteristics	high humidity operation	Operation times	: 10 ⁶ , rated voltage applied	i asseu	
		Double amplitude	: 1.5 mm 0.059 inch	Passed	
		Vibration	: 10 to 55 Hz		
		Applied vibration direction	: X, Y, Z 3 directions		
Mechanical		Time	: 2 hrs each		
characteristics		Dropping height	: 75 cm 29.528 inch	Passed	
	Dropping resistance	Times	: 2 times	rasseu	
	Terminal strength	Pulling strength	: 9.8 N {1 kgf}, 10 sec	Passed	
	reminal strength	Bending strength	: 4.9 N {0.5 kgf}, left and right 90 ° 1 time	Passeu	
	Soldorbility	Temperature	: 230 ℃ 446 °F	Passad	
Soldering	Solderbility	Time	: 5 sec	Passed	
characteristics	Heat resistance (DID)	Temperature	: 260 ℃ 500 °F	December	
	Heat resistance (DIP)	Time	: 10 sec	Passed	

Note: For details other than listed above, please consult us.

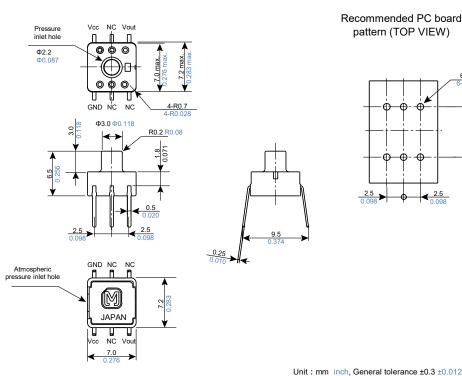
Items	Criteria
Offset valtage	Variation amount
Output span voltage	within ±2.5 %FS of value

Dimensions

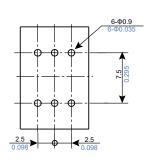
The CAD data of the products with a

CAD data mark can be downloaded from: http://industrial.panasonic.com/

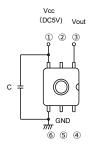
● Standard type S package (Terminal direction : DIP terminal Pressure inlet hole length : 3 mm 0.118 inch) ADP51□0



Recommended PC board pattern (TOP VIEW)



Terminal connection diagram

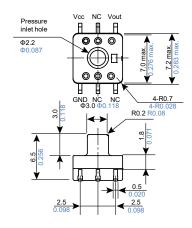


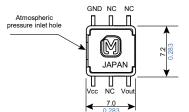
Terminal No.	Name
1	Vcc (Power supply ⊕)
2	NC (No connection)
3	Vout (Output)
4	NC (No connection)
5	NC (No connection)
6	GND (Ground)

Note: leave terminal "No connection" unconnected.

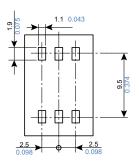
● Standard type S package (Terminal direction : SMD terminal Pressure inlet hole length : 3 mm 0.118 inch) ADP52□0

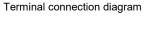
CAD data

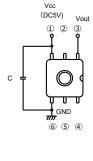




Recommended PC board pattern (TOP VIEW)







Terminal No.	Name
1	Vcc (Power supply ⊕)
2	NC (No connection)
3	Vout (Output)
4	NC (No connection)
5	NC (No connection)
6	GND (Ground)

Unit: mm_inch. General tolerance ±0.3 ±0.012

Note: leave terminal "No connection" unconnected.

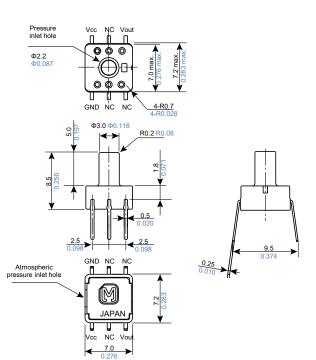
Dimensions

The CAD data of the products with a

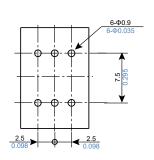
CAD data mark can be downloaded from: http://industrial.panasonic.com/

● Standard/Economy type M package (Terminal direction : DIP terminal Pressure inlet hole length : 5 mm 0.197 inch) ADP51□1 ADP51 □ 1/ADP51A11

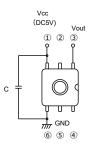
CAD data



Recommended PC board pattern (TOP VIEW)



Terminal connection diagram

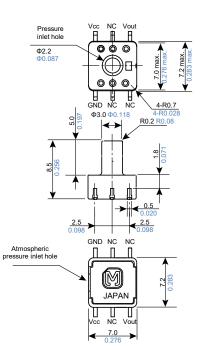


Terminal No.	Name
1	Vcc (Power supply ⊕)
2	NC (No connection)
3	Vout (Output)
4	NC (No connection)
5	NC (No connection)
6	GND (Ground)

Note: leave terminal "No connection" unconnected.

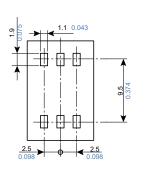
● Standard/Economy type M package (Terminal direction: SMD terminal Pressure inlet hole length: 5 mm 0.197 inch) ADP52□1

CAD data

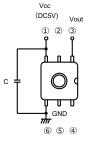


Recommended PC board pattern (TOP VIEW)

Unit: mm_inch_General tolerance +0.3 +0.012



Terminal connection diagram



Name
Vcc (Power supply ⊕)
NC (No connection)
Vout (Output)
NC (No connection)
NC (No connection)
GND (Ground)

Note: leave terminal "No connection" unconnected.

Unit: mm inch, General tolerance ±0.3 ±0.012

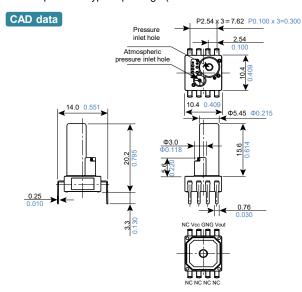
10.0

Dimensions

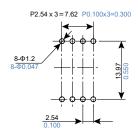
The CAD data of the products with a

CAD data mark can be downloaded from: http://industrial.panasonic.com/

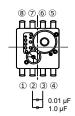
• Low pressure type P package (Terminal direction : DIP terminal, Pressure inlet hole length : 15.6 mm 0.614 inch) ADP51B63



Recommended PC board pattern (BOTTOM VIEW)



Terminal connection diagram



Unit : mm inch, General tolerance $\pm 0.3 \pm 0.012$

Terminal No.	Name
1	NC (No connection)
2	Vcc (Power supply⊕)
3	GND (Ground)
4	Vout (Output)

Terminal No.	Name
5	NC (No connection)
6	NC (No connection)
7	NC (No connection)
8	NC (No connection)

Note: leave terminal "No connection" unconnected.



Explanation of terms

■ Pressure object

This is what can be used to activate the pressure sensor.

(The Panasonic Corporation pressure sensor can be used with gas.)

■ Rated pressure

The pressure value up to which the specifications of the pressure sensor are guaranteed.

■ Maximum applied pressure

The maximum pressure that can be applied to the pressure sensor, after which, when the pressure is returned to below the rated pressure range, the specifications of the pressure sensor are guaranteed.

■ Temperature compensation range

The temperature range across which the specification values of the pressure sensor are guaranteed.

■ Drive current (voltage)

The supply current (voltage) required to drive a pressure sensor.

■ Output span voltage

The difference between the rated output voltage and the offset voltage. The output span voltage is also called the full-scale voltage (FS).

Offset voltage

The output voltage of a pressure sensor when no pressure is applied.

■ Rated pressure output voltage

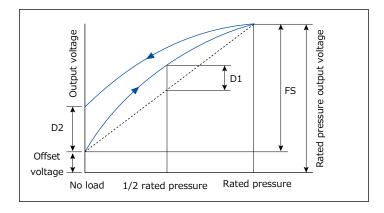
Output voltage when rated pressure is applied.

Linearity

When the pressure is varied from no load to the rated pressure, the linearity is the amount of shift between the straight line that joins the no-load voltage value and the rated pressure voltage value (expressed as the ratio of the amount of shift (D1) at half of the rated pressure value with respect to the full scale voltage (FS)).

Output hysteresis

The ratio of the difference (D2) in the noload output voltages when the pressure is varied from no load to the rated pressure then reduced back to no load, with respect to the full scale voltage (FS).



■ Offset voltage temperature characteristic

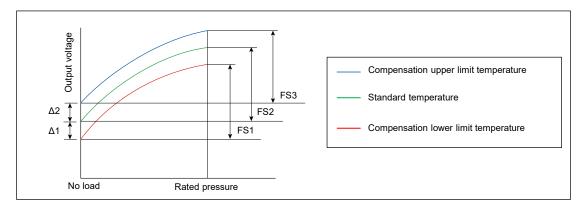
The variation of the offset voltage with changes in ambient temperature. The difference between the offset voltage at the standard temperature and the offset values at the compensation lower limit temperature (low temperature) (D1) and compensation upper limit temperature (high temperature) (D2) are obtained, and the offset voltage temperature characteristic is expressed as the ratio of the larger of these two differences (absolute) with respect to the full scale voltage (FS).



Explanation of terms

■ Temperature sensitivity characteristic

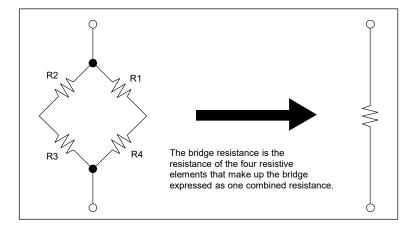
The variation of the sensitivity with changes in ambient temperature (variation in full scale (FS)). The difference between the full scale voltage at the standard temperature (FS) and the full scale values at the compensation lower limit temperature (low temperature) (FS1) and compensation upper limit temperature (high temperature) (FS2) are obtained, and the offset voltage temperature characteristic is expressed as the ratio of the larger of these two differences (FS1 - FS and FS2 - FS (absolute)) with respect to the full scale voltage (FS).



■ Bridge resistance

Refers to the resistance value of a piezo resistance formed on a monolithic silicon substrate. For example, the values of the resistances R1 to R4 in the bridge are typically 5 k Ω each.

* When the resistances of the resistive elements R1 to R4 that comprise the bridge are 5 kΩ each, the equivalent composite resistance of the bridge is $5k\Omega$ (3 kΩ bridges are also available).



Overall accuracy

Accuracy of offset voltage and rated pressure output voltage within the temperature compensation range.



Guidelines and precautions regarding the technical information and use of our products described in this online catalog.

- If you want to use our products described in this online catalog for applications requiring special qualities or reliability, or for applications where the failure or malfunction of the products may directly jeopardize human life or potentially cause personal injury (e.g. aircraft and aerospace equipment, traffic and transportation equipment, combustion equipment, medical equipment, accident prevention, anti-crime equipment, and/or safety equipment), it is necessary to verify whether the specifications of our products fit to such applications. Please ensure that you will ask and check with our inquiry desk as to whether the specifications of our products fit to such applications use before you use our products.
- The quality and performance of our products as described in this online catalog only apply to our products when used in isolation. Therefore, please ensure you evaluate and verify our products under the specific circumstances in which our products are assembled in your own products and in which our products will actually be used.
- Please ensure the safety by means of protection circuit, redundant circuit etc. in your system design in order to prevent the occurrence of life crisis and other serious damages due to the failure of our products.
- The products and product specifications described in this online catalog are subject to change for improvement without prior notice. Therefore, please be sure to request and confirm the latest product specifications which explain the specifications of our products in detail, before you finalize the design of your applications, purchase, or use our products.
- The technical information in this online catalog provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.
- If any of our products, product specifications and/or technical information in this catalog is to be exported, the laws and regulations of the exporting country, especially with regard to security and export control, shall be observed.

<Regarding the Certificate of Compliance with the EU RoHS Directive/REACH Regulations>

- The switchover date for compliance with the RoHS Directive/REACH Regulations varies depending on the part number or series of our products.
- When you use the inventory of our products for which it is unclear whether those products are compliant with the RoHS Directive/REACH Regulation, please select "Sales Inquiry" in the website inquiry form and contact us.

Please note that we do not owe any liability and responsibility if our products are used beyond the description of this catalog or without complying with precautions in this catalog.



⚠ Application Guidelines (PS-A)

1. Mounting

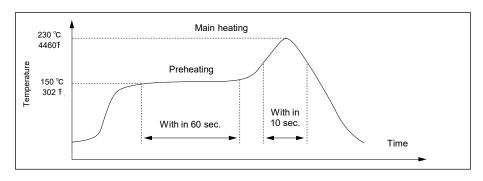
Use the land of the printed-circuit board on which the sensor is securely fixed.

2. Soldering

Avoid the external thermal influence as the product has a limited thermal capacity due to its compact structure. Heat deformation may damage the sensor or deteriorate its performance. Use the non-corrosive rosin flux. Prevent the flux from entering into the inside of the product as the sensor is exposed to the atmosphere.

(1) Manual soldering

- Raise the temperature of the soldering tip between 260 and 300 °C 500 and 572 °F (30 W) and solder within 5 seconds.
- The sensor output may vary if the load is applied on the terminal during soldering.
- · Keep the soldering tip clean.
- (2) DIP soldering (DIP Terminal)
 - · Keep the temperature of the DIP solder tank below 260 °C 500 °F and solder within 5 seconds.
 - To avoid heat deformation, do not perform DIP soldering when mounting on the circuit board which has a small thermal capacity.
- (3) Reflow soldering (SMD Terminal)
 - The recommended reflow temperature profile conditions are given below.



- · We recommend the screen solder printing method as the method of cream.
- · Please refer to the recommended PC board specification diagram for the PC board foot pattern.
- Self alignment may not always work as expected, therefore, please carefully the position of the terminals and pattern.
- The temperature of the profile is assumed to be a value measured with the printed wiring board of the terminal neighborhood.
- Please evaluate solderbility under the actual mounting conditions since welding and deformation of the pressure inlet port may occur due to heat stress depending on equipments or conditions.
- (4) Rework soldering
 - · Complete rework at a time.
 - \cdot Use a flattened soldering tip when performing rework on the solder bridge. Do not add the flux.
 - Keep the soldering tip below the temperature described in the specifications.
- (5) Avoid drop and rough handling as excessive force may deform the terminal and damage soldering and rough handling as excessive force may deform the terminal and damage soldering
- (6) Keep the circuit board warpage within 0.05 mm of the full width of the sensor.
- (7) After soldering, do not apply stress on the soldered part when cutting or bending the circuit board.
- (8) Prevent human hands or metal pieces from contacting with the sensor terminal.

 Such contact may cause anomalous outlets as the terminal is exposed to the atmosphere.
- (9) After soldering, prevent chemical agents from adhering to the sensor when applying coating to avoid insulation deterioration of the circuit board.
- (10) Please consult us concerning leadfree soldering.

3. Wire connection

- (1) Correctly wire as in the connection diagram. Reverse connection may damage the product and degrade the performance.
- (2) Do not use idle terminals to prevent damages to the sensor.



4. Cleaning

- (1) Prevent cleaning liquid from entering the inside of the product as the sensor is exposed to the atmosphere.
- (2) Do not perform ultrasonic cleaning in order to prevent damages to the product.

5. Environment

- (1) Avoid use and storage in the corrosive gas (organic solvent, sulfurous acid and hydrogen sulfide gases) which negatively affects the product.
- (2) Install the capacitor on the power supply terminal of the sensor and stabilize supply voltage to maintain a superimposed noise resistance. Recommended installation is to arrange 0.1 μF and 1,000 pF in parallel. Before use, check the noise resistance and select/add the optimal capacitor.
- (3) Use surge absorbers as applying the external surge voltage may damage the internal circuit.
- (4) Malfunction may occur near electric noises from static electricity, lightning, broadcast or amateur radio stations and mobile phones
- (5) Avoid use in a place where these products come in contact with water as the sensor does not have a splash proof construction.
- (6) Avoid use in an environment where these products cause dew condensation.
 When water attached to the sensor chip freezes, the sensor output may be fluctuated or damaged.
- (7) Due to the structure of the pressure sensor chip, the output varies under light. Do not expose the sensor chip to light when applying a voltage by using a transparent tube.
- (8) Do not apply high-frequency oscillation, such as ultrasonic waves, to the product.

6. Quality check under actual use conditions

These specifications are for individual components. Before use, carefully check the performance and quality under actual use conditions to enhance stability.

7. Other precautions

- (1) The wrong mounting method and the pressure range may invite the risk of accidents.
- (2) Only applicable pressure medium is dry air. Avoid use in the corrosive gas (organic solvent, sulfurous acid and hydrogen sulfide gases) or other mediums containing moisture or foreign substances. Such mediums may damage or break the product.
- (3) The pressure sensor chip is located inside the pressure introduction port. Do not insert foreign substances, such as wires, into the port as those substances may damage the chip and close the port. Do not block the atmosphere introduction port.
- (4) Use electric power within the rated power range. Use beyond the range may damage the product.
- (5) Follow below instructions as static electricity may damage the product.
 - For Storage, short the circuit between terminals by using conductive substances or wrap the whole chip with aluminum foil. For storage and transportation, avoid plastic containers which are easily electrified.
 - Before use, connect electrified materials on desk and operators to the ground in order to safely discharge static electricity.
- (6) Carefully select and fix tubes, introduction pipes and products based on the working voltage. Please contact us for any inquires.
- (7) After mounding the pressure sensor, prevent the potting agent from entering the pressure and the atmosphere introduction ports when coating the circuit board. Use the elastic resin as the heated resin may expand, contract and apply pressure to the sensor. After coating, carefully check if the sensor can be used.